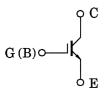
TOSHIBA IGBT Module Silicon N Channel IGBT

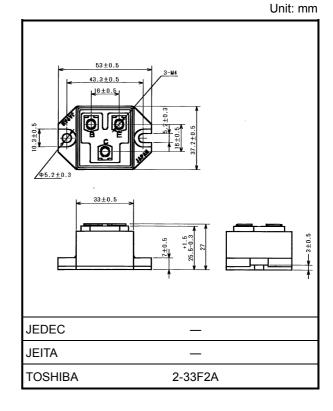
MG100J1BS11

High Power Switching Applications Motor Control Applications

- Enhancement-mode
- The electrodes are isolated from case.

Equivalent Circuit





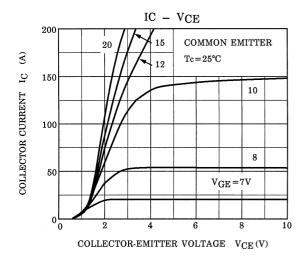
Maximum Ratings (Ta = 25°C)

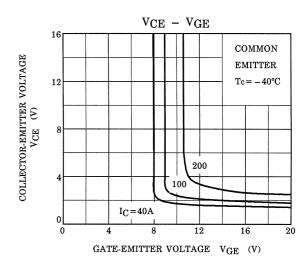
Characteristic		Symbol	Rating	Unit	
Collector-emitter voltage		V _{CES}	600	V	
Gate-emitter voltage		V _{GES}	±20	V	
Collector current	DC	Ic	100	Α	
Collector current	1ms	I _{CP}	200		
Collector power dissipation (Tc = 25°C)		PC	300	W	
Junction temperature		Tj	150	°C	
Storage temperature range		T _{stg}	-40 to 125	°C	
Isolation voltage		V _{Isol}	2500 (AC 1 Minute)	٧	
Screw torque (Terminal / mounting)		_ 2/3		N m	

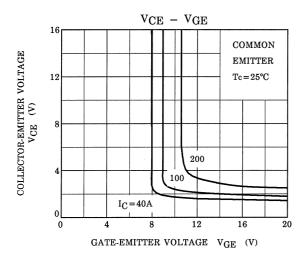
Electrical Characteristics (Ta = 25°C)

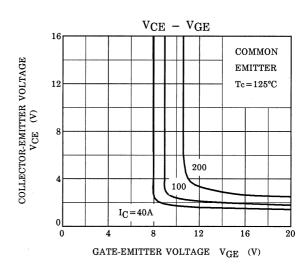
Characteristic Symbol Test Condition		Test Condition	Min	Тур.	Max	Unit	
Gate leakage current		I _{GES}	V _{GE} = ±20V, V _{CE} = 0	_	_	±500	nA
Collector cut-off cu	ırrent	I _{CES}	V _{CE} = 600V, V _{GE} = 0	_	_	1.0	mA
Gate-emitter cut-of	ff voltage	V _{GE(off)}	V _{CE} = 5V, I _C = 100mA	3.0	_	6.0	V
Collector-emitter saturation voltage		V _{CE(sat)}	I _C = 100A, V _{GE} = 15V	_	2.3	2.7	V
Input capacitance		C _{ies}	V _{CE} = 10V, V _{GE} = 0, f = 1MHz	_	8200	_	pF
Switching time	Rise time	t _r	15V 24Ω C C C C C C C C C C C C C C C C C C C	_	0.3	0.8	μs
	Turn-on time	t _{on}		_	0.4	1.0	
	Fall time	t _f		_	0.6	1.0	
	Turn-off time	t _{off}		_	1.0	1.6	
Thermal resistance R _{th}		R _{th(j-c)}	_	_	_	0.41	°C/W

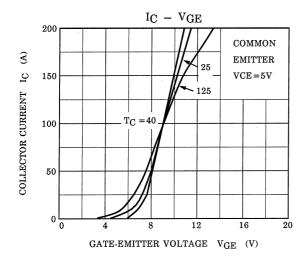
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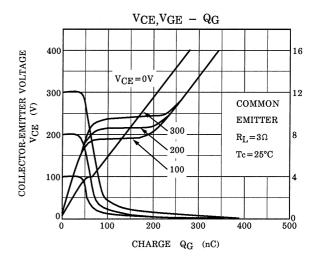


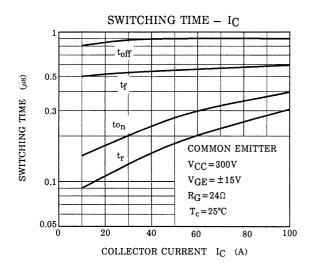


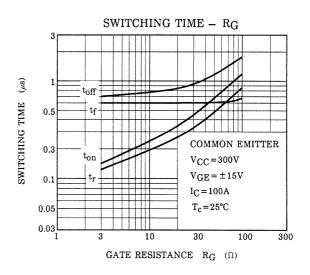


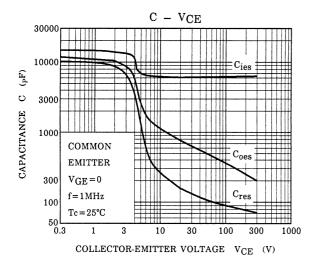


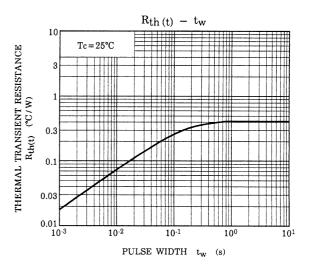


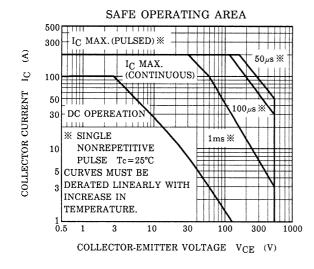


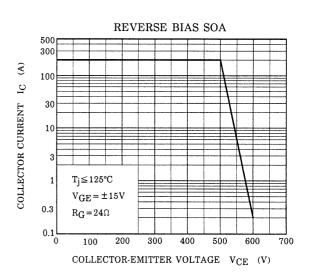












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